

Date: May 16, 1995

Reference: Standards Proposal No. 3388, Proposed New Standard "PCS 1900 MHz IS-136 Based Air Compatability Standard" (if approved, to be published as J-STD-011)

Company Name: QUALCOMM Incorporated

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Contact Person Regarding Patents and Intellectual Property Matters:

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(Name Printed)

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On behalf of the above company, and being authorized by the company to make such representations, we indicate the following:

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With respect to any essential patents held or controlled by the company, pending or anticipated to be filed necessary to implement the above Standard (mark with an X those applicable):

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The company states that: (i) A license will be made available without compensation to applicants desiring to utilize the license for the purpose of implementing the standard or

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Finally,

The company has provided a copy of its licensing terms and conditions along with a statement of the number of independent licensees, if any, which have accepted or indicated acceptance of terms and conditions of the license attached to this form in an envelope sealed by the patent holder for transmittal to ANSI for its review prior to authorizing the publication of the proposed Standard.

NOTE: If not attached, indicate when the envelope will be received at TIA. Indicate the company name and proposed Standard number on the outside. Date due at TIA: September 8, 1995

Agreed, on behalf of the above Company:

(Signature)

Name (printed): Steven R. Altman

Date: 8/8/95